









AM38 SERIES

HIGH VOLTAGE ▲ Si MOSFET RELAY

SILICON Si MOSFET RELAY ▲ DIP and SMD type

Switches AC or DC load

650V load voltage

Input TTL / CMOS compatible

Moisture Sensitivity Level ▲ MSL 3

UL 1577 approved ▲ File no E344988

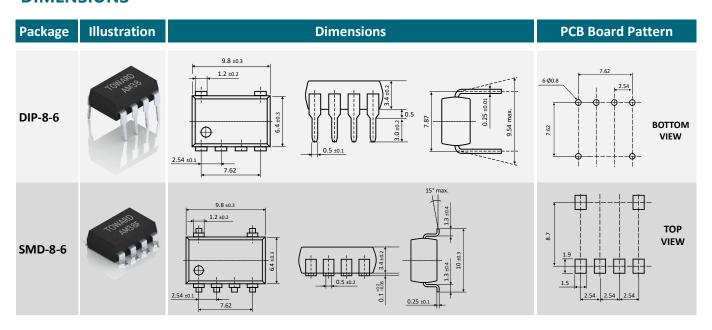
SPECIFICATION

Item		Characteristics
Contact Form		1 Form A ▲ Normally open switch
Load Voltage	V _L	650V
Operation LED Current	I _{F ON}	5mA
Load Current	l _L	800mA
On-Resistance	R _{on}	1Ω
Output Capacitance	C _{OUT}	2100pF
Low Off-State Leakage Current	I _{LEAK}	1μA at 650V _{DC}

APPLICATIONS

Automatic Test	I/O	Industrial	Measurement	Security	Sensing	Telecom
Equipment	Modules	Automation	Equipment	Equipment	Equipment	Equipment
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DIMENSIONS



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ABSOLUTE MAXIMUM RATINGS ▲ AMBIENT TEMPERATURE T_A = 25°C

	Item	Condition	Symbol	Va	lue	Unit
	Outline package			DIP-8-6	SMD-8-6	
Туре	Part number			AM38	AM38F	
	Output channels			1	1	Channel
	Continuous LED Current		IF	5	0	mA
loout	Peak LED Current	100 Hz, Duty 1%	I _{FP}	50	00	mA
Input	LED Reverse Voltage		V_{R}	į	V	
	Input Power Dissipation		P _{IN}	75		mV
	Load Voltage		V_{L}	650 (AC peak or DC)		V
Output	Load Current		IL	80	00	mA
Output	Peak Load Current	1 ms, 1 shot	I _{PEAK}	24	00	mA
	Output Power Dissipation		Pout	1000		mW
	Total Power Dissipation		P_{T}	10	50	mW
	I/O Breakdown Voltage		V _{I/O}	37	50	V_{RMS}
Relay	I/O Breakdown Voltage (Suffix-H)		V _{I/O}	50	00	V_{RMS}
	Operating Temperature Range		T_OPR	-40 to	o +85	°C
	Storage Temperature Range		T_{STG}	-40 to	+100	°C

ELECTRICAL CHARACTERISTICS ▲ **AMBIENT TEMPERATURE** T_A = 25°C

	Item	Condition	Symbol	Min.	Тур.	Max.	Unit
	LED Forward Voltage	I _F = 10mA	V _F	1	1.37	1.5	V
Input	Operation LED Current		I _F ON		1	5	mA
	Recovery LED Voltage		V _F OFF	0.5	1.2		V
	On-Resistance Drain to Drain (tested within 1 sec.)	I _F =5mA, I _L =Rating	Ron		1	1.3	Ω
Output	Off-State Leakage Current	V _L = 650V	I _{LEAK}			1	μΑ
	Output Capacitance	V _L =0V, f=1MHz	C_OUT		2100		pF
Trans-	Turn-On Time	I _F =10mA, I _L =Rating	ton		0.7	3	ms
mission	Turn-Off Time	I _F =10mA, I _L =Rating	toff		0.15	0.5	ms
Coupled	I/O Insulation Resistance		R _{I/O}	10 ¹⁰			Ω
Coupled	I/O Capacitance	f=1MHz	C _{I/O}		1.3		pF

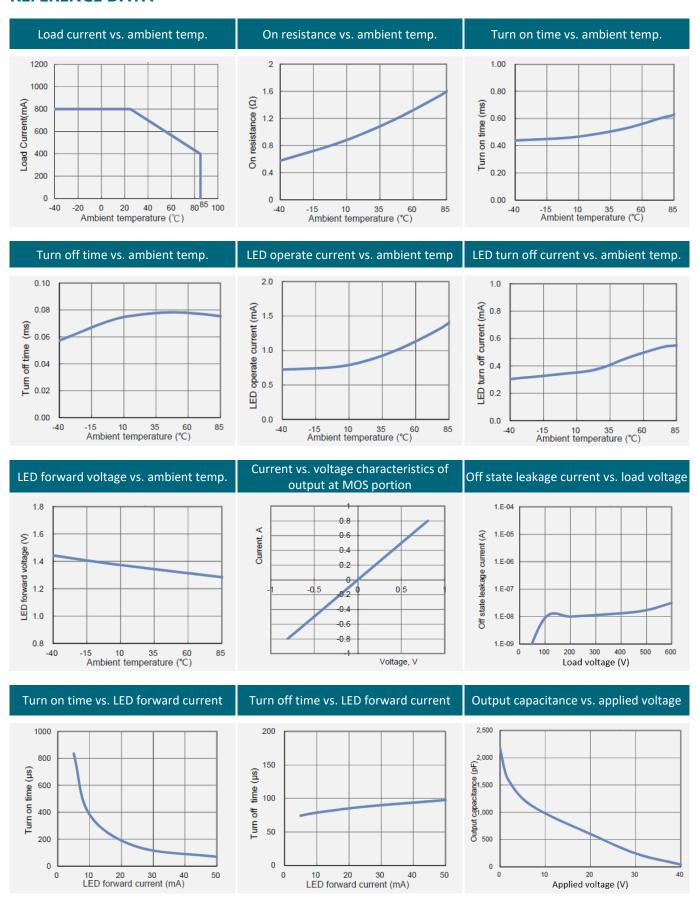
PIN DESCRIPTION AND PART NUMBER

Circuit Diagram	Pin Description	Part No.	Package	Packing
1 2 3 4	1 NC 2 Anode (+) • LED 3 Cathode (-) • LED 4 NC 5,8 Drain • MOSFET	AM38 AM38F AM38F-R1	DIP-8-6 SMD-8-6 SMD-8-6	Tube (45pcs) Tube (45pcs) Reel (1000pcs)

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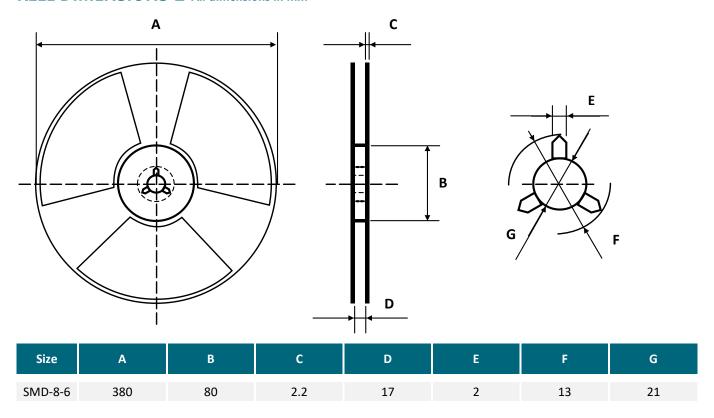
REFERENCE DATA



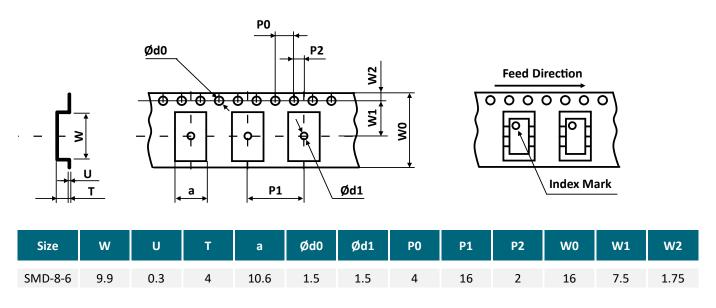
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REEL DIMENSIONS ▲ All dimensions in mm



TAPE DIMENSIONS ▲ All dimensions in mm





PACKING QUANTITIES

Tape and Reel Packing	PCS/Reel
SMD-8-6	1000

Tube Packing	PCS/Tube	Tubes/Box	Units/Box
DIP-8-6	45	30	1350

STORAGE AND HANDLING CONDITIONS

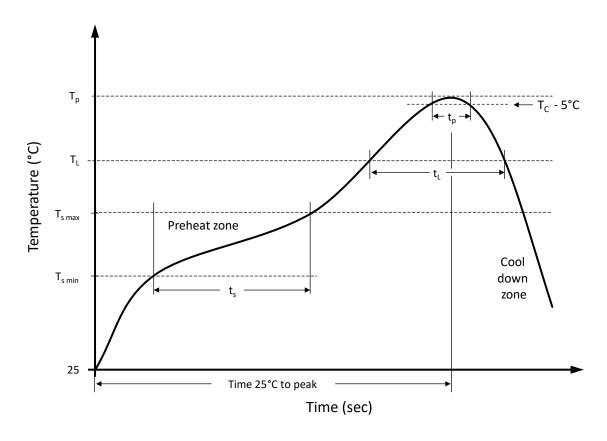
ESD level	Floor life	Conditions	MSL
HBM class 2	Unlimited	T _A < 30°C, RH < 85%	1

LOAD CONNECTING METHOD

Туре	Load	Connection	Feature
6 pins	AC or DC	V _L (AC or DC)	Control bi-directional signal



RECOMMENDED REFLOW SOLDERING PROFILE A SMD PACKAGE

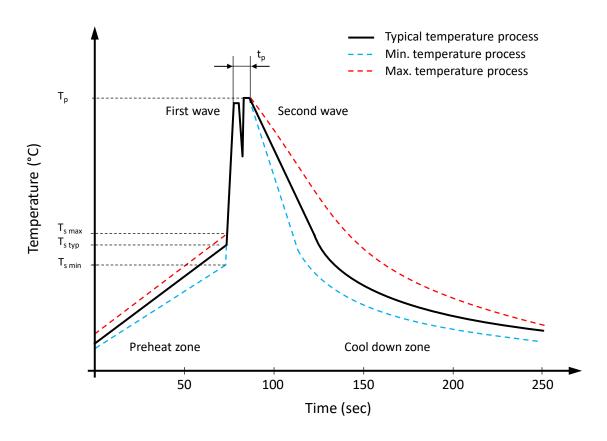


Recommended reflow soldering conditions ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	T _{s min}	100 °C	150 °C
Preheat temperature max.	T _{s max}	150 °C	200 °C
Preheat time t _s from T _{s min} to T _{s max}	ts	120 seconds	120 seconds
Ramp-up rate (T _L to T _p)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	T∟	183 °C	217 °C
Time t _L maintained above T _L	t _L	150 seconds max.	60 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	tp	20 seconds max.	30 seconds max.
Ramp-down rate (T _L to T _p)		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes



RECOMMENDED WAVE SOLDERING PROFILE & THT PACKAGE



Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value ▲ Sn-Pb Assembly	Value ▲ Pb-free Assembly
Preheat temperature min.	T _{s min}	100 °C	100 °C
Preheat temperature typical	T _{s typ}	120 °C	120 °C
Preheat temperature max.	T_{smax}	130 °C	130 °C
Preheat time t _s from T _{s min} to T _{s max}	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	tp	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



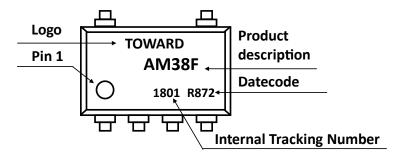
PRODUCT CODE

Example: AM38F series ▲ 1 Form A ▲ 650V ▲ SMD-8-6 ▲ Tape & Reel

	AM	3	8		-	F	:	R	1
	Package	Sei	ries	Sp	ecial Suffix	Ту	pe	Pac	king
AM	6 Pin ▲ 1 Form A	38	650V	Blank H	Standard High Insulation	Blank F	DIP SMD	Blank R1	Tube Reel

PRODUCT MARKING

Example: AM38F series ▲ 1 Form A ▲ 650V ▲ SMD-8-6 ▲ Tape & Reel



DATE CODE

Example: R872

R		8		7		2	
Material Characteristics		Year		Month		Week of the Month	
R H	RoHS compliant Halogen free	8 9 A B C G	2018 2019 2020 2021 2022 2026	1 2 3 4 5 	Jan Feb Mar Apr May Dec	1 2 3 4	1 st 2 nd 3 rd 4 th



RELIABILITY TESTS **A STANDARD**

Standard: JESD22-A

No.	Test	Test Specification	Test Standard	Test Limits
1	Moisture Sensitivity Level Test	Bake condition: Temperature: 125°C; Duration 24 hours Soak condition: Temperature: 30°C; Humidity: 60% RH Duration 192 hours Reflow condition: Peak temperature: 260°C Duration: 3 cycles	JESD22-A113H	No abnormal phenome- non was found. Functional test passed.
2	High Temperature Storage Test	Temperature: 150°C Duration: 500 hours	JESD22-A103E	No abnormal phenomenon was found. Functional test passed.
3	Temperature Cycling Test	Temperature range: -55°C to +125°C -55°C for 30 minutes +125°C for 30 minutes Duration: 100 cycles with 1 cycle = 70 minutes	JESD22-A104E	No abnormal phenome- non was found. Functional test passed.
4	Low Temperature Storage Test	Temperature: -40°C Duration: 500 hours	JESD22-A119E	No abnormal phenome- non was found. Functional test passed.
5	Temperature & Humidity Storage Test	Temperature: 85°C Humidity: 85% RH Duration: 500 hours	JESD22-A101D	No abnormal phenome- non was found. Functional test passed.
6	Highly Accelerated Temperature and Humidity Stress Test	Temperature: 130°C Humidity: 85% RH Duration: 96 hours	JESD22-A-118B	No abnormal phenome- non was found. Functional test passed.



REVISION TABLE

Revision	Date	Status	Notes
001	01/10/2021	Initial release	Initial publication

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